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# FAN7080\_GF085 Half Bridge Gate Driver

## Features

- Automotive Qualified to AEC Q100
- Floating Channel for Bootstrap Operation to +600 V
- Tolerance to Negative Transient Voltage on VS Pin
- VS-pin dv/dt Immune
- Gate Drive Supply Range from 5.5 V to 20 V
- Under-Voltage Lockout (UVLO)
- CMOS Schmitt-triggered Inputs with Pull-down
- High Side Output In-phase with Input
- IN input is 3.3 V/5 V Logic Compatible and Available on 15 V Input
- Matched Propagation Delay for both Channels
- Dead Time Adjustable

## Applications

- Junction Box
  - Half and full bridge application in the motor drive system
- Related Product Resources

## Description

The FAN7080\_GF085 is a half-bridge gate drive IC with reset input and adjustable dead time control. It is designed for high voltage and high speed driving of MOSFET or IGBT, which operates up to 600 V. Fairchild's high-voltage process and common-mode noise cancellation technique provide stable operation in the high side driver under high-dV/dt noise circumstances. An advanced level-shift circuit allows high-side gate driver operation up to  $V_S = -5$  V (typical) at  $V_{BS} = 15$  V. Logic input is compatible with standard CMOS outputs. The UVLO circuits for both channels prevent from malfunction when  $V_{CC}$  and  $V_{BS}$  are lower than the specified threshold voltage. Combined pin function for dead time adjustment and reset shutdown make this IC packaged with space saving SOIC-8 Package. Minimum source and sink current capability of output driver is 250 mA and 500 mA respectively, which is suitable for junction box application and half and full bridge application in the motor drive system.



Figure 1. 8-Lead, SOIC, Narrow Body

## Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FAN7080M_GF085	-40°C ~ 125°C	8-Lead, Small Outline Integrated Circuit (SOIC), JEDEC MS-012, .150 inch Narrow Body	Tube
FAN7080MX_GF085			Tape & Reel



## Pin Configuration

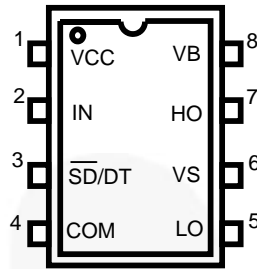


Figure 4. Pin Assignment (Top Through View)

## Pin Descriptions

Pin #	Name	I/O	Pin Function Description
1	V <sub>CC</sub>	P	Driver Supply Voltage
2	IN	I	Logic input for high and low side gate drive output
3	/SD/DT	I	Shutdown Input and dead time setting
4	COM	P	Ground
5	LO	A	Low side gate drive output for MOSFET Gate connection
6	V <sub>S</sub>	A	High side floating offset for MOSFET Source connection
7	HO	A	High side drive output for MOSFET Gate connection
8	V <sub>B</sub>	P	Driver Output Stage Supply

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
$V_S$	High-Side Floating Offset Voltage	$V_B-25$	$V_B+0.3$	V
$V_B$	High-Side Floating Supply Voltage	-0.3	625	V
$V_{HO}$	High-Side Floating Output Voltage	$V_S-0.3$	$V_B+0.3$	V
$V_{LO}$	Low-Side Floating Output Voltage	-0.3	$V_{CC}+0.3$	V
$V_{CC}$	Supply Voltage	-0.3	25	V
$V_{IN}$	Input Voltage for IN	-0.3	$V_{CC}+0.3$	V
$I_{IN}$	Input Injection Current <sup>(1)</sup>		+1	mA
PD	Power Dissipation <sup>(2,3)</sup>		0.625	W
$\theta_{JA}$	Thermal Resistance, Junction to Ambient <sup>(2)</sup>		200	°C/W
$T_J$	Junction Temperature		150	°C
$T_{STG}$	Storage Temperature	-55	150	°C
ESD	Human Body Model (HBM)		1000	V
	Charge Device Model (CDM)		500	

### Notes:

- Guaranteed by design. Full function, no latchup. Tested at 10 V and 17 V.
- The Thermal Resistance and power dissipation rating are measured per below conditions:  
JESD51-2: Integral circuits thermal test method environmental conditions, natural convection/Still Air  
JESD51-3: Low effective thermal conductivity test board for leaded surface-mount packages.
- Do not exceed power dissipation ( $P_D$ ) under any circumstances.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
$V_B^{(4)}$	High-Side Floating Supply Voltage (DC) Transient: -10 V at 0.1 $\mu$ S	$V_S+6$	$V_S+20$	V
$V_S$	High-Side Floating Supply Offset Voltage (DC) Transient: -25 V(max.) at 0.1 $\mu$ S at $V_{BS} < 25$ V	-5	600	V
$V_{HO}$	High-Side Output Voltage	$V_S$	$V_B$	V
$V_{LO}$	Low-Side Output Voltage	0	$V_{CC}$	V
$V_{CC}$	Supply Voltage for Logic Input	5.5	20	V
$V_{IN}$	Logic Input Voltage	0	$V_{CC}$	V
dv/dt	Allowable Offset Voltage Slew Rate <sup>(5)</sup>		50	V/nS
$T_{PULSE}$	Minimum Pulse Width <sup>(5,6)</sup>	1100		nS
$F_S$	Switching Frequency <sup>(6)</sup>		200	KHz
$T_A$	Operating Ambient Temperature	-40	125	°C

### Notes:

- The  $V_S$  offset is tested with all supplies based at 15 V differential
- Guaranteed by design.
- When  $V_{DT} = 1.2$  V. Refer to Figures 5, 6, 7 and 8.

## Electrical Characteristics

Unless otherwise specified  $-40^{\circ}\text{C} \leq T_A \leq 125^{\circ}\text{C}$ ,  $V_{CC} = 15\text{ V}$ ,  $V_{BS} = 15\text{ V}$ ,  $V_S = 0\text{ V}$ ,  $C_L = 1\text{ nF}$

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>V<sub>CC</sub> and V<sub>BS</sub> Supply Characteristics</b>						
V <sub>CCUV+</sub> V <sub>BSUV+</sub>	V <sub>CC</sub> and V <sub>BS</sub> Supply Under-Voltage Positive going Threshold			4.2	5.5	V
V <sub>CCUV-</sub> V <sub>BSUV-</sub>	V <sub>CC</sub> and V <sub>BS</sub> Supply Under-Voltage Negative going Threshold		2.8	3.6		V
V <sub>CCUVH</sub> V <sub>BSUVH</sub>	V <sub>CC</sub> and V <sub>BS</sub> Supply Under-Voltage Hysteresis		0.2	0.6		V
t <sub>DUVCC</sub> t <sub>DUVBS</sub>	Under-Voltage Lockout Response Time	V <sub>CC</sub> : 6 V → 2.5 V or 2.5 V → 6 V	0.5		20	μs
		V <sub>BS</sub> : 6 V → 2.5 V or 2.5 V → 6 V	0.5		20	
I <sub>LK</sub>	Offset Supply Leakage Current	V <sub>B</sub> = V <sub>S</sub> = 600 V		20	50	μA
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> Supply Current	V <sub>IN</sub> = 0 or 5 V, V <sub>S</sub> DT = 1.2 V	20	75	150	μA
I <sub>QCC</sub>	Quiescent V <sub>CC</sub> Supply Current	V <sub>IN</sub> = 0 or 5 V, V <sub>S</sub> DT = 1.2 V		350	1000	μA
<b>Input Characteristics</b>						
V <sub>IH</sub>	High Logic level Input Voltage		2.7			V
V <sub>IL</sub>	Low Logic Level Input Voltage				0.8	V
I <sub>IN+</sub>	Logic Input High Bias Current	V <sub>IN</sub> = 5 V		10	50	μA
I <sub>IN-</sub>	Logic Input Low Bias Current	V <sub>IN</sub> = 0 V		0	2	μA
V <sub>DT</sub>	V <sub>DT</sub> Dead Time Setting Range		1.2		5.0	V
V <sub>SD</sub>	V <sub>SD</sub> Shutdown Threshold Voltage			0.8	1.2	V
R <sub>S</sub> DT	High Logic Level Resistance for /SD /DT	V <sub>S</sub> DT = 5 V	100	500	1100	kΩ
I <sub>S</sub> DT-	Low Logic Level Input bias Current for /SD /DT	V <sub>S</sub> DT = 0 V		1	2	μA
<b>Output Characteristics</b>						
V <sub>OH</sub> (HO)	High Level Output Voltage (V <sub>CC</sub> - V <sub>HO</sub> )	I <sub>O</sub> = 0			0.1	V
V <sub>OL</sub> (HO)	Low Level Output Voltage (V <sub>HO</sub> )	I <sub>O</sub> = 0			0.1	V
I <sub>O+</sub> (HO)	Output High, Short-Circuit Pulse Current		250	300		mA
I <sub>O-</sub> (HO)	Output Low, Short-Circuit Pulse Current		500	600		mA
R <sub>OP</sub> (HO)	Equivalent Output Resistance				60	Ω
R <sub>ON</sub> (HO)					30	
V <sub>OH</sub> (LO)	High Level Output Voltage (V <sub>B</sub> - V <sub>LO</sub> )	I <sub>O</sub> = 0			0.1	V
V <sub>OL</sub> (LO)	Low Level Output Voltage (V <sub>LO</sub> )	I <sub>O</sub> = 0			0.1	V
I <sub>O+</sub> (LO)	Output High, Short-Circuit Pulse Current		250			mA
I <sub>O-</sub> (LO)	Output Low, Short-Circuit Pulse Current		500			mA
R <sub>OP</sub> (LO)	Equivalent Output Resistance				60	Ω
R <sub>ON</sub> (LO)					30	

## Dynamic Electrical Characteristics

Unless otherwise specified  $-40^{\circ}\text{C} \leq T_A \leq 125^{\circ}\text{C}$ ,  $V_{CC} = 15\text{ V}$ ,  $V_{BS}=15\text{ V}$ ,  $V_S = 0\text{ V}$ ,  $C_L = 1\text{ nF}$

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{ON}$	Turn-On Propagation Delay <sup>(7)</sup>	$V_S=0\text{ V}$		750	1500	ns
$t_{OFF}$	Turn-Off Propagation Delay	$V_S=0\text{ V}$		130	250	ns
$t_R$	Turn-On Rise Time			40	150	ns
$t_F$	Turn-Off Fall Time			25	400	ns
$D_T$	Dead Time, LS Turn-off to HS Turn-on and HS Turn-on to LS Turn-off	$V_{IN} = 0$ or $5\text{ V}$ at $V_{DT} = 1.2\text{ V}$	250	650	1200	ns
		$V_{IN} = 0$ or $5\text{ V}$ at $V_{DT} = 1.2\text{ V}$	1600	2100	2600	
$M_{DT}$	Dead Time Matching Time	$DT1 - DT2$ at $V_{DT} = 1.2\text{ V}$		35	110	ns
		$DT1 - DT2$ at $V_{DT} = 3.3\text{ V}$			300	
$M_{TON}$	Delay Matching, HS and LS Turn-on	$V_{DT} = 1.2\text{ V}$		25	110	ns
$M_{TOFF}$	Delay Matching, HS and LS Turn-off	$V_{DT} = 1.2\text{ V}$		15	60	ns
$t_{SD}$	Shutdown Propagation Delay			180	330	ns
$F_{S1}$	Switching Frequency	$V_{CC} = V_{BS} = 20\text{ V}$			200	Khz
$F_{S2}$		$V_{CC} = V_{BS} = 5.5\text{ V}$			200	

### Notes:

7.  $t_{ON}$  includes DT

### Typical Waveforms

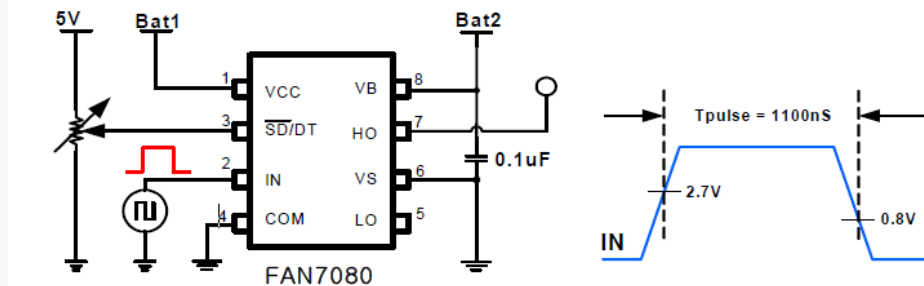


Figure 5. Short Pulse Width Test Circuit and Pulse Width Waveform

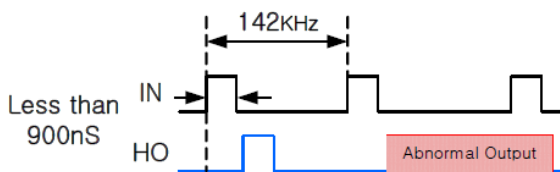


Figure 6. Abnormal Output Waveform with Pulse Width

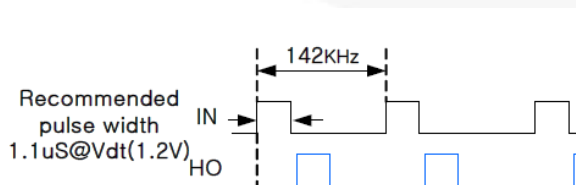


Figure 7. Recommendation of Pulse width Output Waveform

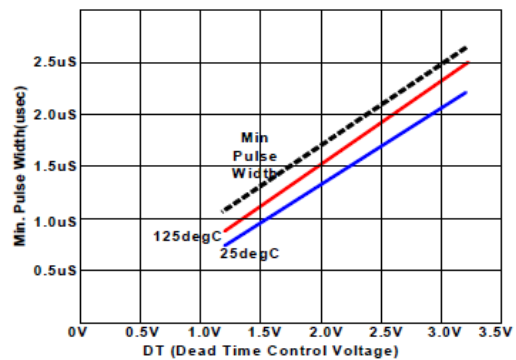


Figure 8. Pulse Width vs. VDT

Typical Performance Characteristics

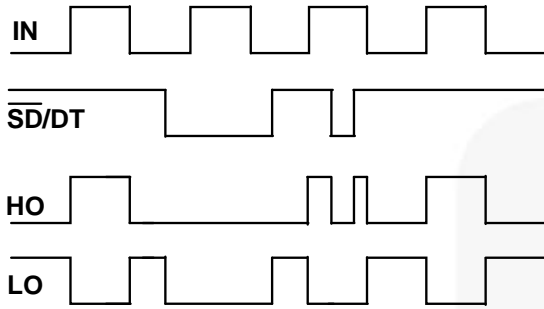


Figure 9. Input/Output Timing Diagram

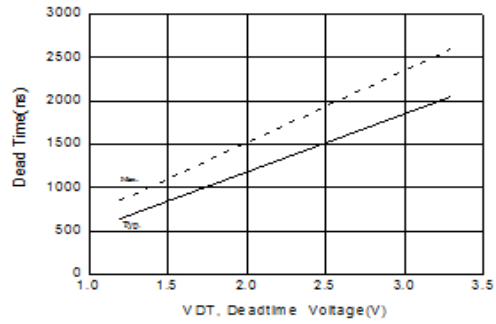
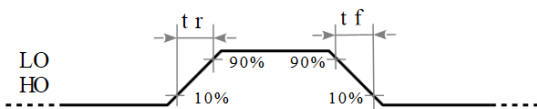


Figure 10. Dead Time vs. V<sub>DT</sub> (V<sub>CC</sub>=V<sub>BS</sub>=15 V, -40°C < T<sub>J</sub> < 125°C)



Note: not drawn to scale

Figure 11. Switching Time Waveform Definitions

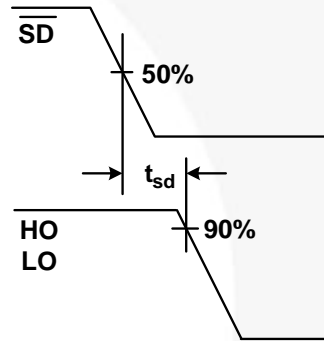


Figure 12. Shutdown Waveform Definitions

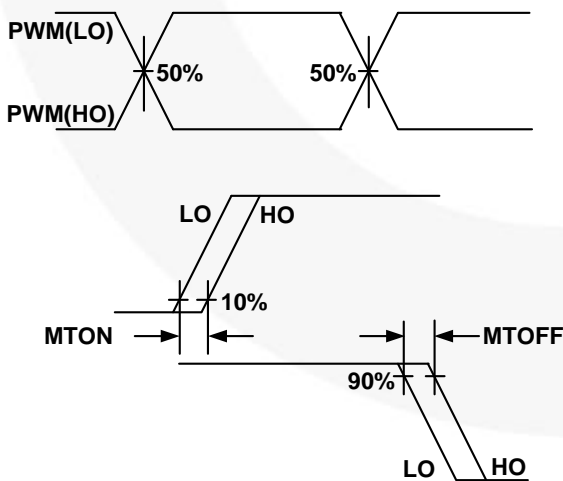
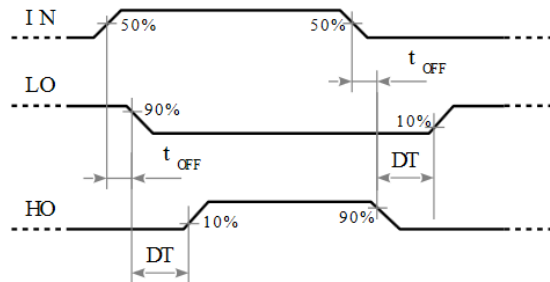


Figure 13. Delay Matching Waveform Definitions



Note: not drawn to scale

Figure 14. Dead Time Waveform Definitions



Typical Performance Characteristics

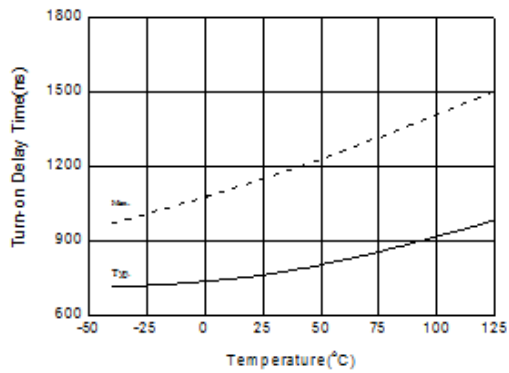


Figure 15. Turn-on Delay Time of HO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $C_L=1\text{ nF}$ )

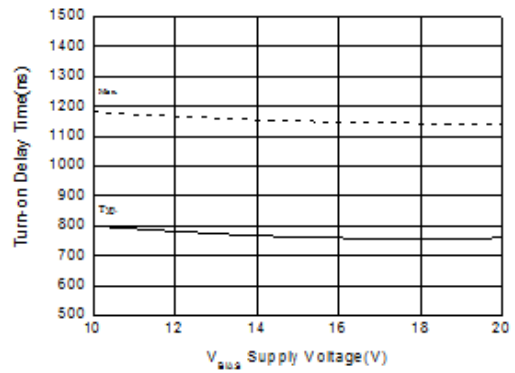


Figure 16. Turn-on Delay Time of HO vs.  $V_{BS}$  Supply Voltage ( $V_{CC}=15\text{ V}$ ,  $C_L=1\text{ nF}$ ,  $T_A=25^\circ\text{C}$ )

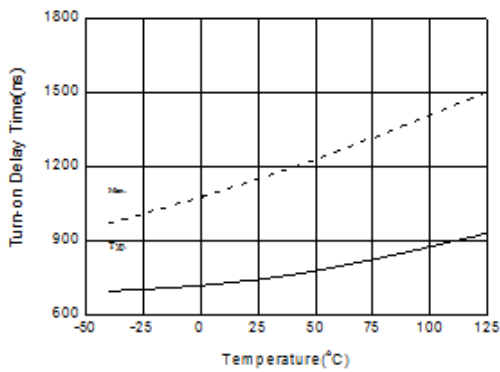


Figure 17. Turn-on Delay Time of LO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $C_L=1\text{ nF}$ )

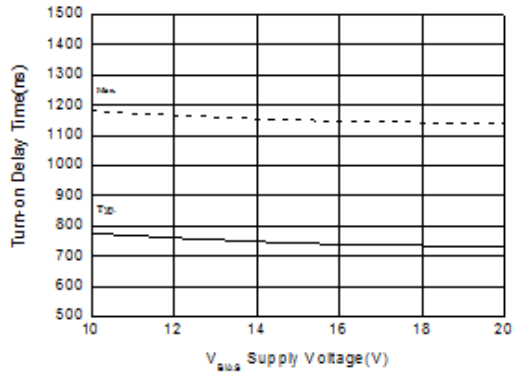


Figure 18. Turn-on Delay Time of LO vs.  $V_{BS}$  Supply Voltage ( $V_{CC}=15\text{ V}$ ,  $C_L=1\text{ nF}$ ,  $T_A=25^\circ\text{C}$ )

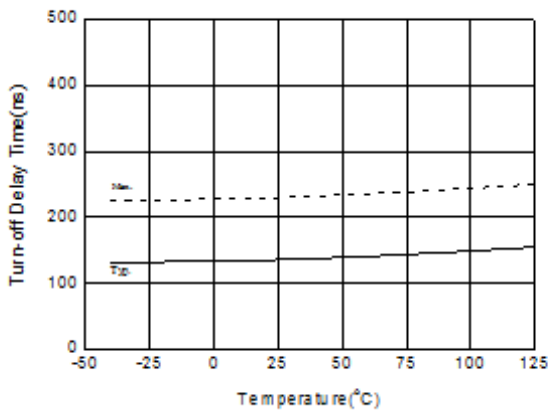


Figure 19. Turn-off Delay Time of HO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $C_L=1\text{ nF}$ )

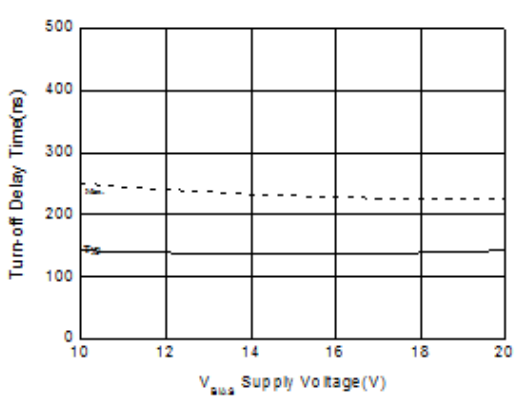


Figure 20. Turn-off Delay Time of HO vs.  $V_{BS}$  Supply Voltage ( $V_{CC}=15\text{ V}$ ,  $C_L=1\text{ nF}$ ,  $T_A=25^\circ\text{C}$ )

Typical Performance Characteristics

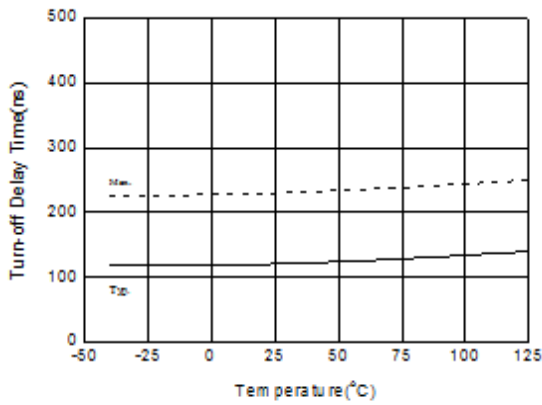


Figure 21. Turn-off Delay Time of LO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $C_L=1\text{ nF}$ )

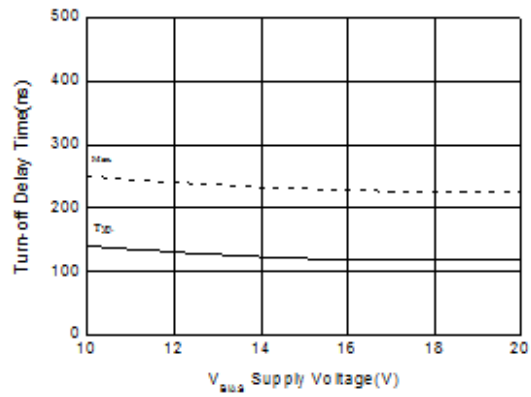


Figure 22. Turn-off Delay Time of LO vs.  $V_{BS}$  Supply Voltage ( $V_{CC}=15\text{ V}$ ,  $C_L=1\text{ nF}$ ,  $T_A=25^\circ\text{C}$ )

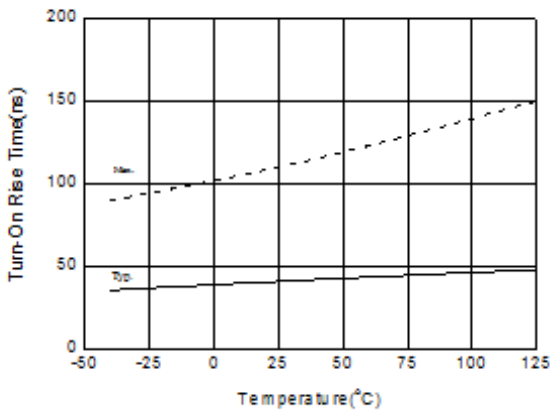


Figure 23. Turn-on Rise Time of HO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $C_L=1\text{ nF}$ )

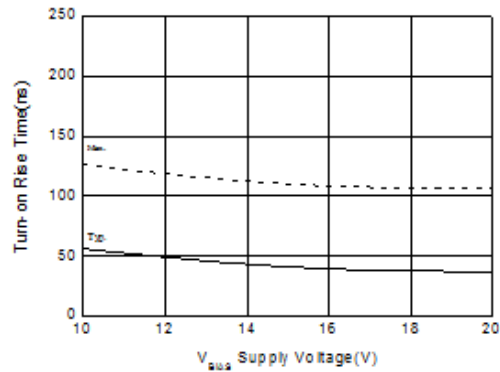


Figure 24. Turn-on Rise Time of HO vs.  $V_{BS}$  Supply Voltage ( $V_{CC}=15\text{ V}$ ,  $C_L=1\text{ nF}$ ,  $T_A=25^\circ\text{C}$ )

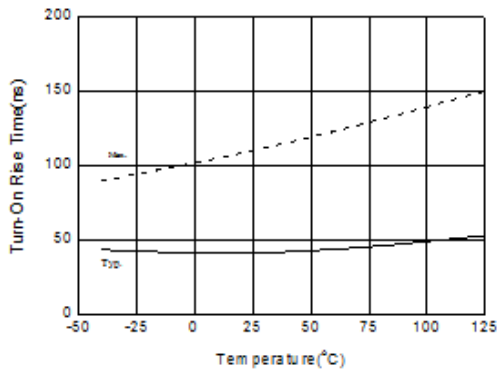


Figure 25. Turn-on Rise Time of LO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $C_L=1\text{ nF}$ )

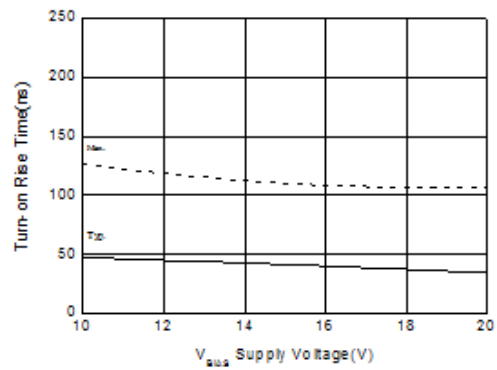


Figure 26. Turn-on Rise Time of LO vs.  $V_{BS}$  Supply Voltage ( $V_{CC}=15\text{ V}$ ,  $C_L=1\text{ nF}$ ,  $T_A=25^\circ\text{C}$ )

## Typical Performance Characteristics

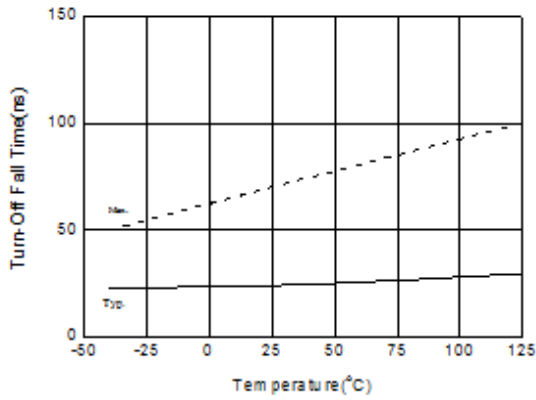


Figure 27. Turn-off Fall Time of HO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $C_L=1\text{ nF}$ )

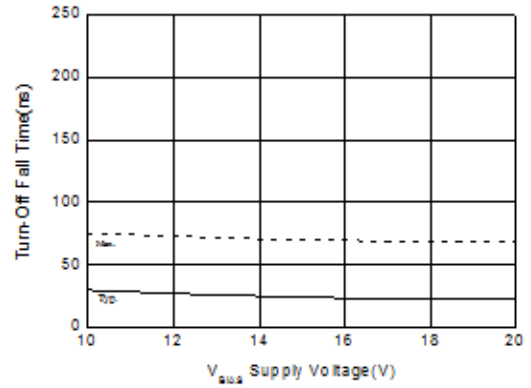


Figure 28. Turn-off Fall Time of HO vs.  $V_{BS}$  Supply Voltage ( $V_{CC}=15\text{ V}$ ,  $C_L=1\text{ nF}$ ,  $T_A=25^\circ\text{C}$ )

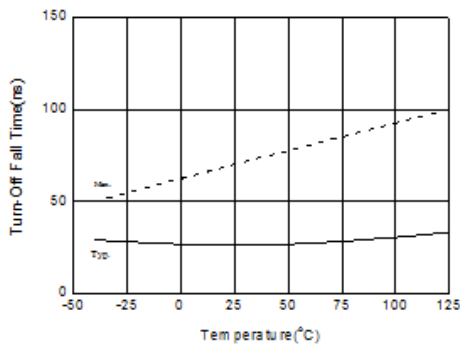


Figure 29. Turn-off Fall Time of LO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $C_L=1\text{ nF}$ )

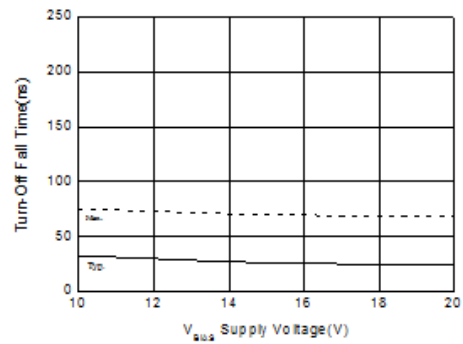


Figure 30. Turn-off Fall Time of LO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $C_L=1\text{ nF}$ )

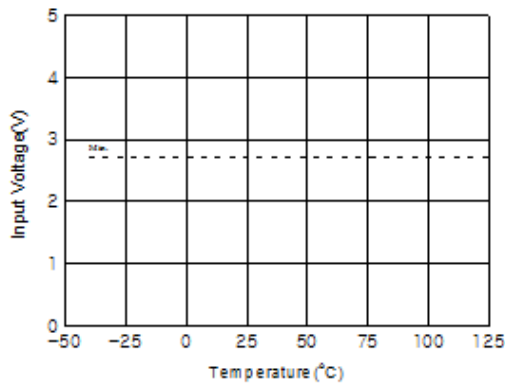


Figure 31. Logic Low Input Voltage vs. Temperature

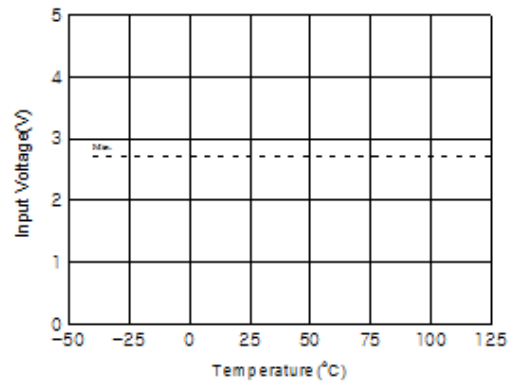


Figure 32. Logic High Input Voltage vs. Temperature

Typical Performance Characteristics

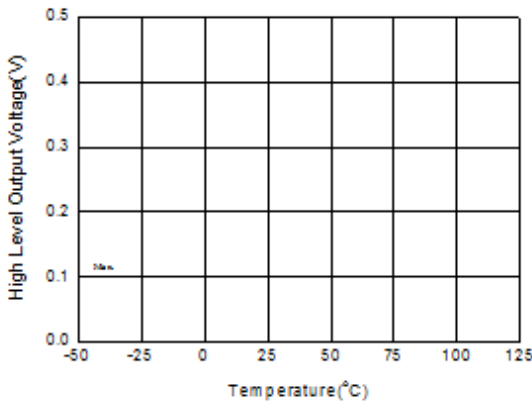


Figure 33. High Level Output of HO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ )

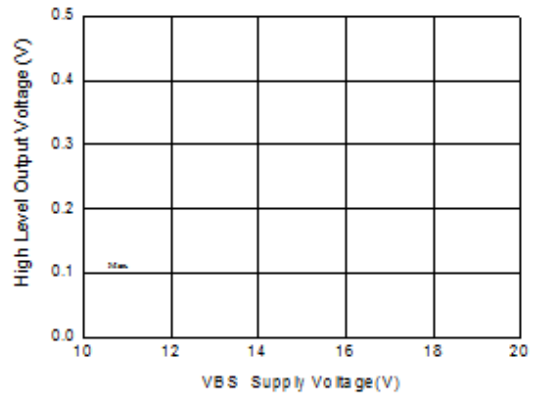


Figure 34. High Level Output of HO vs.  $V_{BS}$  Supply Voltage ( $V_{CC}=15\text{ V}$ ,  $T_A=25^\circ\text{C}$ )

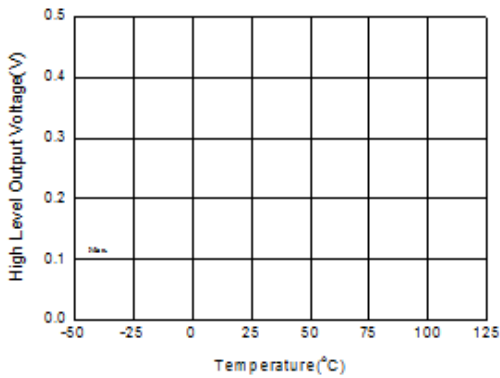


Figure 35. High Level Output of LO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ )

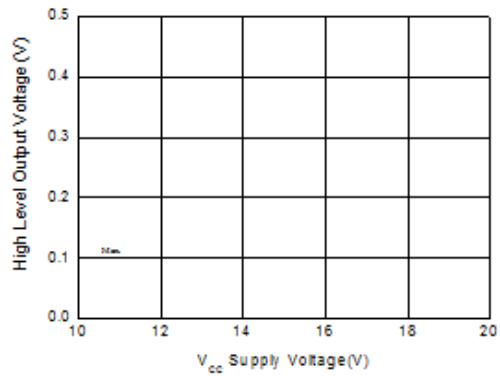


Figure 36. High Level Output of LO vs.  $V_{BS}$  Supply Voltage ( $V_{CC}=15\text{ V}$ ,  $T_A=25^\circ\text{C}$ )

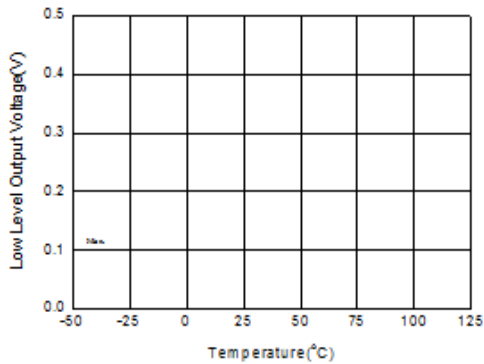


Figure 37. Low Level Output of HO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ )

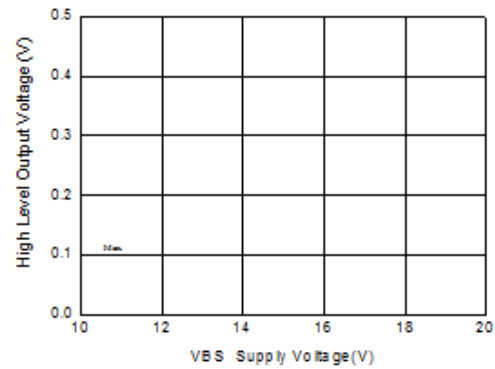


Figure 38. Low Level Output of HO vs.  $V_{BS}$  Supply Voltage ( $V_{CC}=15\text{ V}$ ,  $T_A=25^\circ\text{C}$ )

## Typical Performance Characteristics

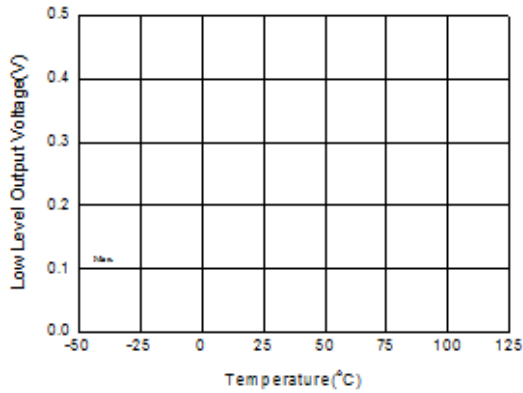


Figure 39. Low Level Output of LO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ )

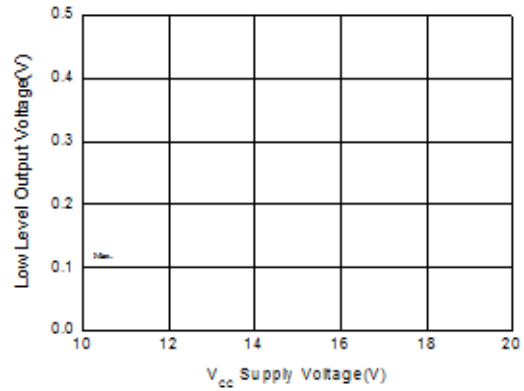


Figure 40. Low Level Output of LO vs.  $V_{CC}$  Supply Voltage ( $V_{CC}=15\text{ V}$ ,  $T_A=25^\circ\text{C}$ )

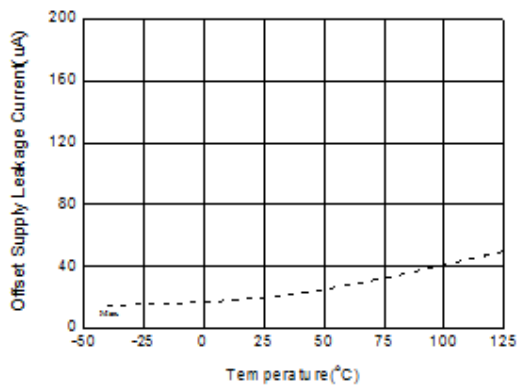


Figure 41. Offset Supply Leakage Current vs. Temperature ( $V_{CC}=V_{BS}=600\text{ V}$ )

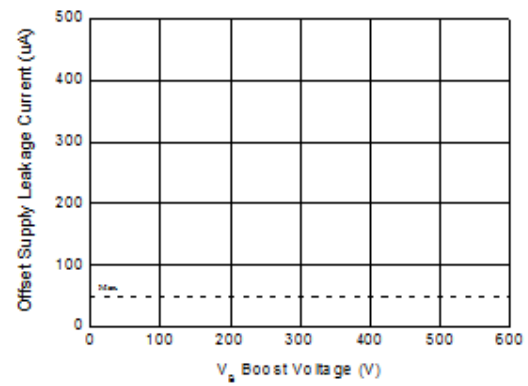


Figure 42. Offset Supply Leakage Current vs.  $V_B$  Boost Voltage ( $V_{CC}=15\text{ V}$ ,  $T_A=25^\circ\text{C}$ )

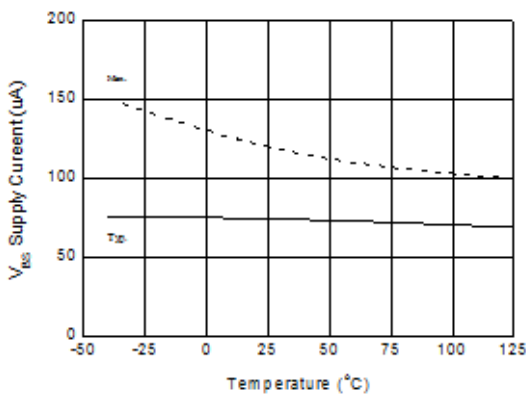


Figure 43.  $V_{BS}$  Supply Current vs. Temperature ( $V_{BS}=15\text{ V}$ )

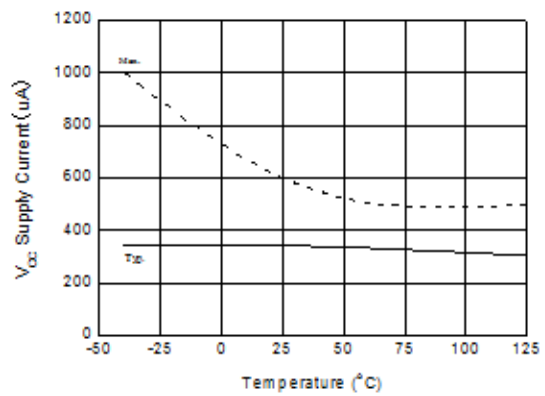


Figure 44.  $V_{CC}$  Supply Current vs. Temperature ( $V_{CC}=15\text{ V}$ )

### Typical Performance Characteristics

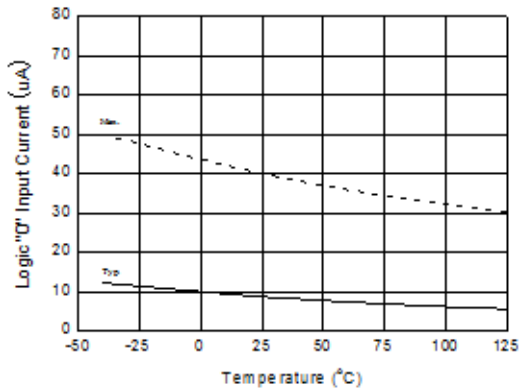


Figure 45. Logic High Input Current vs. Temperature ( $V_{IN}=5\text{ V}$ )

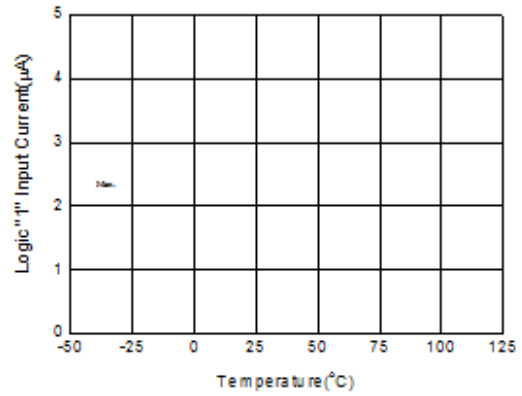


Figure 46. Logic Low Input Current vs. Temperature ( $V_{IN}=5\text{ V}$ )

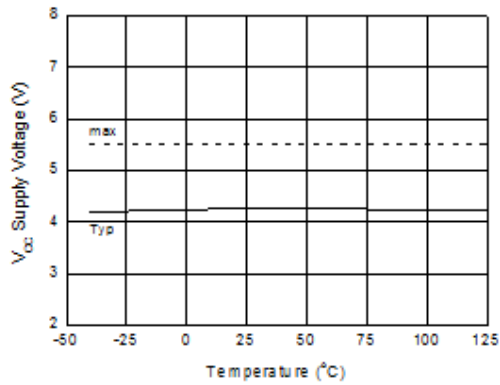


Figure 47.  $V_{CC}$  Under-Voltage Threshold (+) vs. Temperature

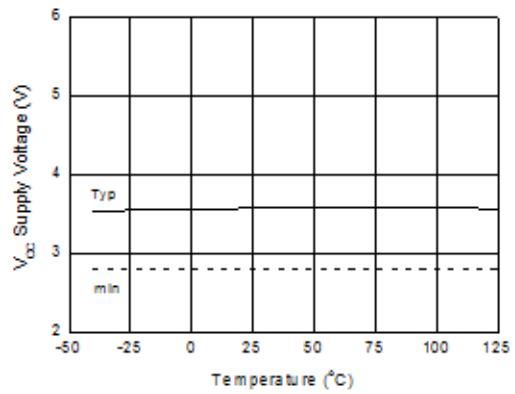


Figure 48.  $V_{CC}$  Under-Voltage Threshold (-) vs. Temperature

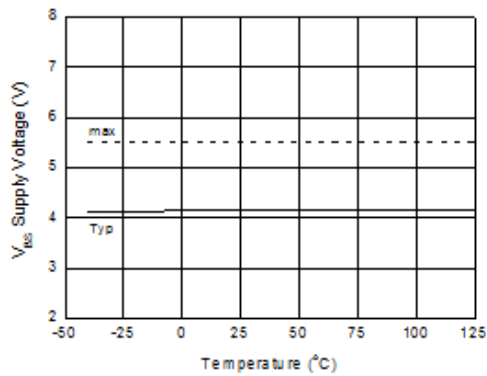


Figure 49.  $V_{BS}$  Under-Voltage Threshold (+) vs. Temperature

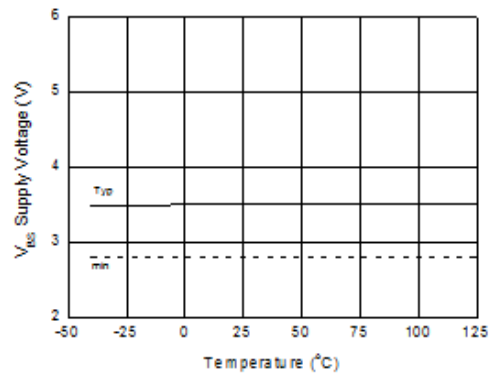


Figure 50.  $V_{BS}$  Under-Voltage Threshold (-) vs. Temperature

## Typical Performance Characteristics

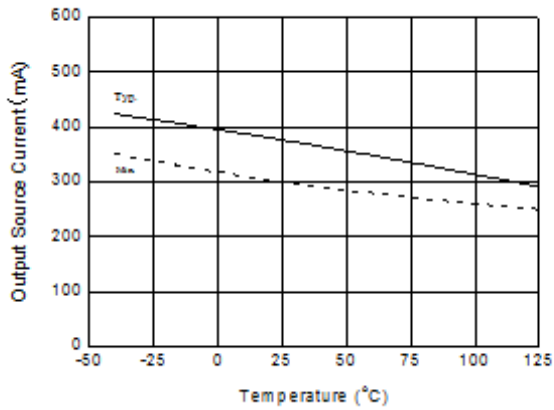


Figure 51. Output Source Current of HO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ )

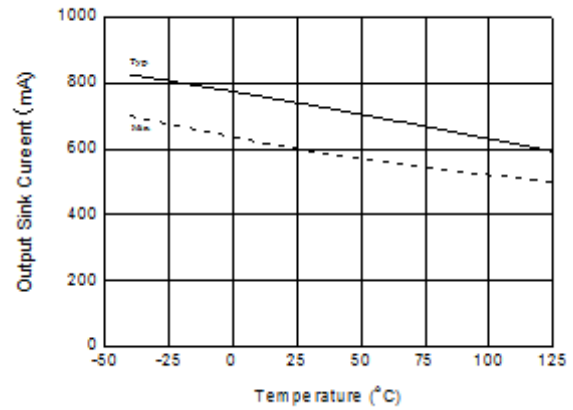


Figure 52. Output Sink Current of HO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ )

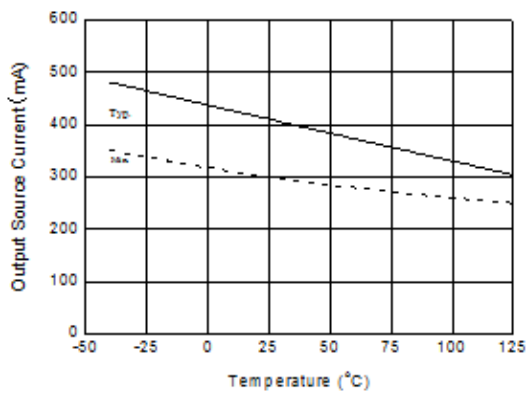


Figure 53. Output Source Current of LO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ )

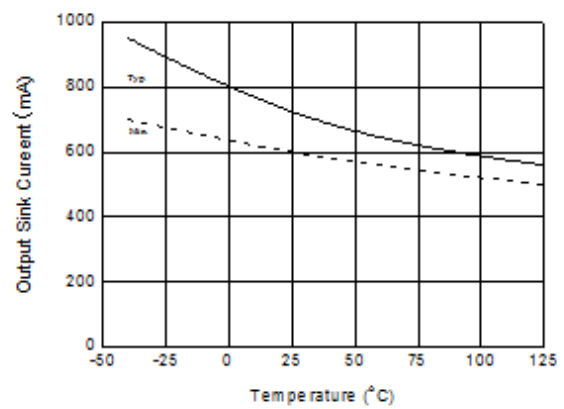


Figure 54. Output Sink Current of LO vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ )

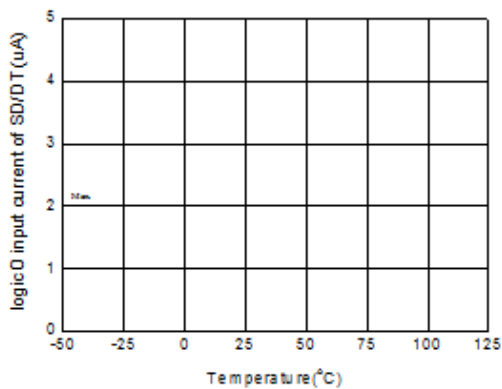


Figure 55. Logic Low Input Current of SD/DT vs. Temperature

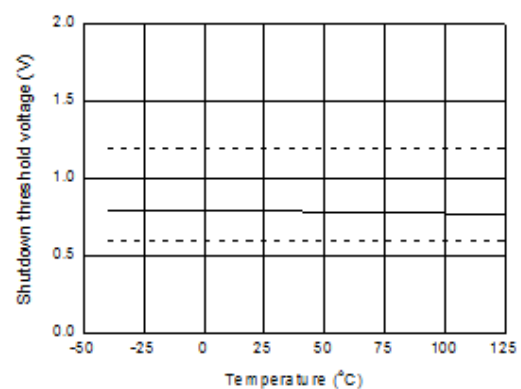


Figure 56. Shutdown Threshold Voltage vs. Temperature

Typical Performance Characteristics

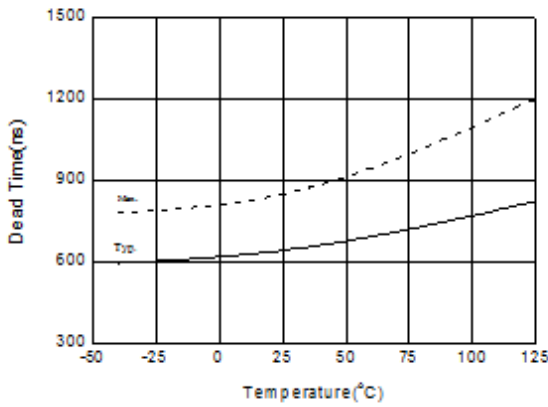


Figure 57. Deadtime vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $V_{DT}=1.2\text{ V}$ )

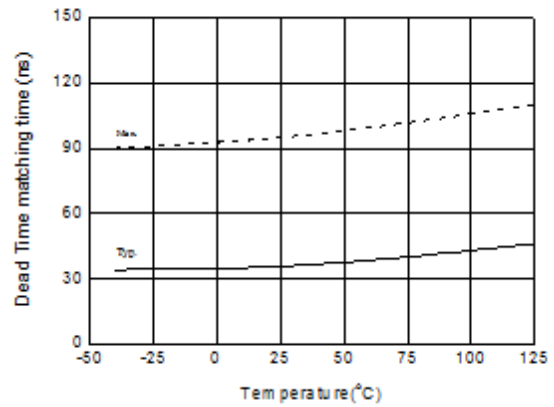


Figure 58. Deadtime Matching Time vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $V_{DT}=1.2\text{ V}$ )

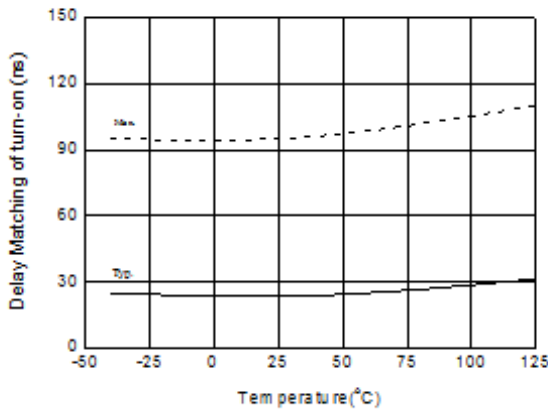


Figure 59. Turn-on Delay Matching vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $V_{DT}=1.2\text{ V}$ )

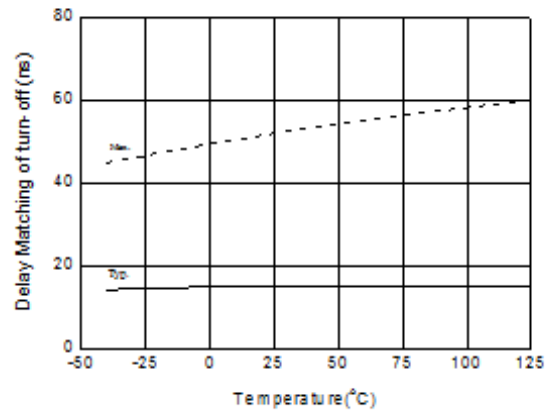


Figure 60. Turn-off Delay Matching vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ ,  $V_{DT}=1.2\text{ V}$ )

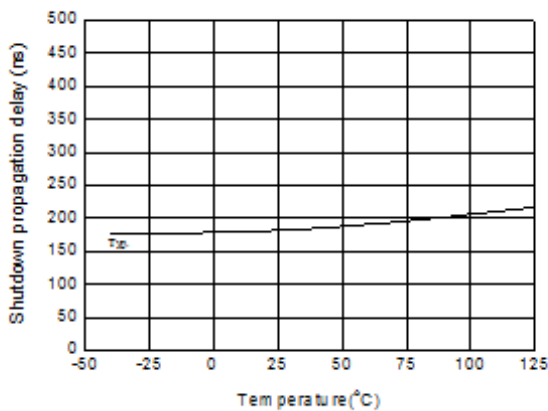


Figure 61. Shutdown Propagation Delay vs. Temperature

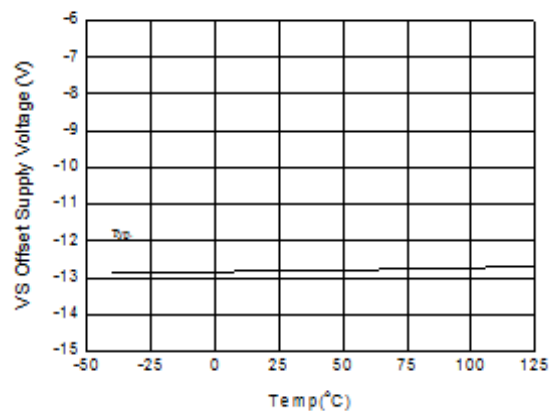
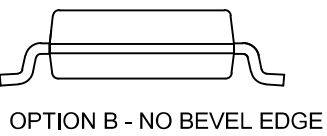
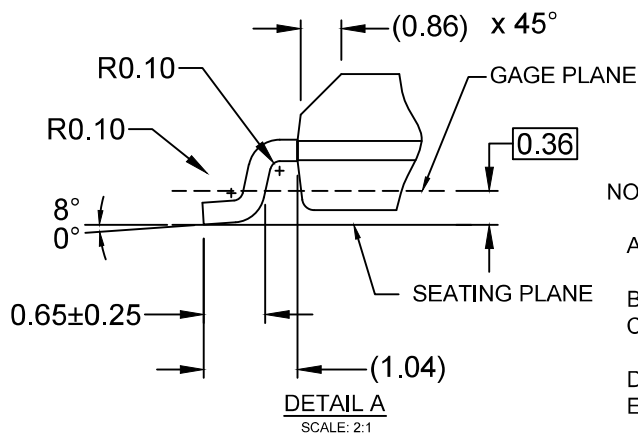
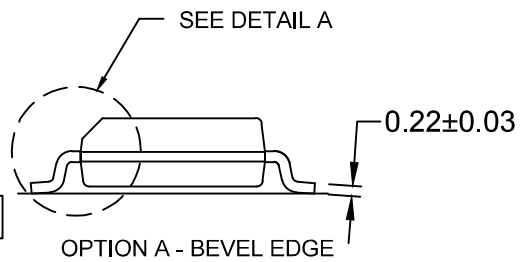
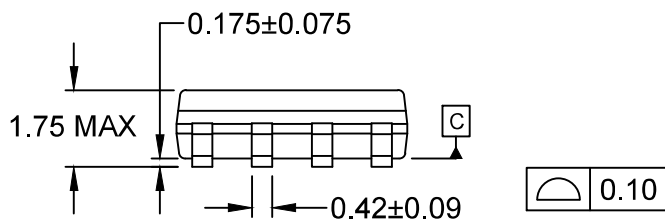
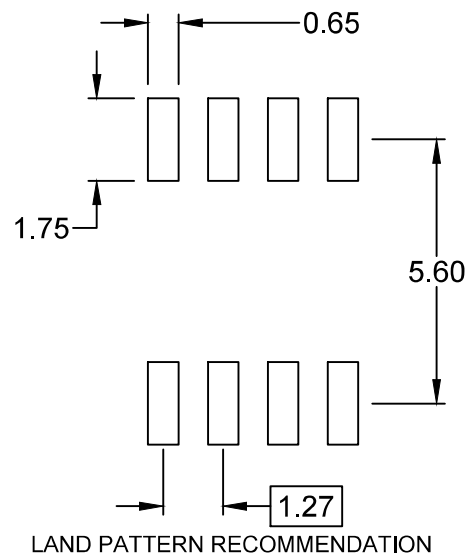
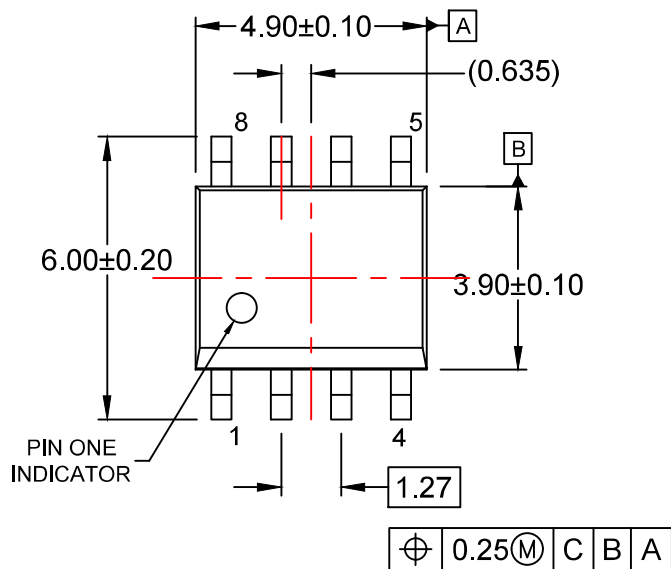


Figure 62. Maximum vs. Negative Offset Voltage vs. Temperature ( $V_{CC}=V_{BS}=15\text{ V}$ )





NOTES:

- A) THIS PACKAGE CONFORMS TO JEDEC MS-012, VARIATION AA.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- D) LANDPATTERN STANDARD: SOIC127P600X175-8M
- E) DRAWING FILENAME: M08Arev16



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